

Armstrong, Kratz, Quintos, Hanson & Brooks, LLP

# **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

### INSTALLATION STRUCTURE OF RELEASE PIPE IN FUEL CELL VEHICLE AND FUEL GAS VEHICLE

				·
the specification	of which is attached hereto unle	ess the following is checked	i	
was filed	November 29, 20 PCT/JP2005/021886		Application Number or PCT Inter	rnational Application
☐ Number		(if applicable).		
I hereby state that amended by any	t I have reviewed and understar amendment referred to above.	nd the contents of the above	e-identified specification, including	ng the claim(s), as
I acknowledge the Regulations, § 1.5		which is material to patenta	bility as defined in Title 37, Code	e of Federal
inventor's certific	reign priority benefits under Tit ate listed below and have also i te that of the application for wh	dentified below any foreig	§ 119 (a) - (d) of any foreign app n application for patent or invento	lication(s) for patent or or's certificate having
a min out	v and of the application for will	ion priority is claimed.		<b>Priority Claimed</b>
77 tot materia	2004-347911	Japan	30-Nov-2004	✓ Yes _ No
(List prior foreign applications. See note A)	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	_ ''' _ '''
(See note B)  I hereby claim the	See attached list for addition benefit under Title 35, United	States Code, § 120 of any	United States application(s) listed	below and, insofar as
provided by the fit material to patenta	rst paragraph of Title 35, United	d States Code, § 112, I ack ode of Federal Regulations	the prior United States application the prior United States application owledge the duty to disclose info. § 1.56 which became available to application.	ormation which is
		· ·		itus
(List prior U.S. Applications)	(Application Serial No.)	(Filing Date)	Patented Pen	ding Abandoned
	(Application Serial No.)	(Filing Date)	Patented Pen	ding Abandoned
	(Application Serial No.)	(Filing Date)	Patented Pend	ding Abandoned
			Patented Pend	

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

#### **Customer Number**

23850 PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

#### **Customer Number**

23850 PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements my jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given name, fan					
	Inventor's Signature Koichi Jahahu		Date March 11, 2006			
	Residence Saitama, Japan					
	Post Office Address c/o HONDA R&D CO., LTD. 4-1, Chuo 1-Chome, Wako-shi, Saitama, 351-0193 Japan					
	Full name of second inventor (given name, family name) Sh		ni TOGASAWA			
	Inventor's Signature Shuichi Togasay	wa	Date March . 70 . 2006			
	Residence Saitama, Japan					
Post Office Address c/o HONDA R&D CO., LTD. 4-1, Chuo 1-Chome, Wako-shi, Saitama, 351-0193 Japan						
	Full name of third inventor (given name, family name	ne) Kentaro	MIURA			
	Inventor's Signature Lantaro min	a	Date March . 20, 2000			
	Residence Saitama, Japan					
	Post Office Address c/o HONDA R&D CO.,LTD. 4-1, Chuo 1-Chome, Wako-shi,					
	Full name of fourth inventor (given name, family na	me)				
	Inventor's Signature		Date			
	Residence	Citizenship				
	Post Office Address	•				
	Full name of fifth inventor (given name, family nam	a)				
	Inventor's Signature		Date			
	Post Office Address					
	Full name of sixth inventor (given name, family name					
	Inventor's Signature		Date			
	Residence	Citizenship				
	Post Office Address					

## **NOTES**

- A. Please list all foreign applications relating to the invention and check "yes" or "no."
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.